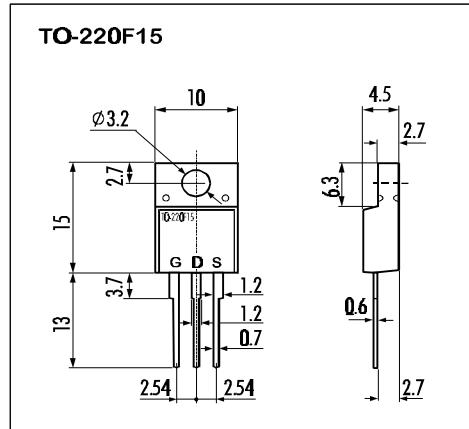


**> Features**

- High Speed Switching
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Voltage
- $V_{GS} = \pm 30V$  Guarantee
- Avalanche Proof

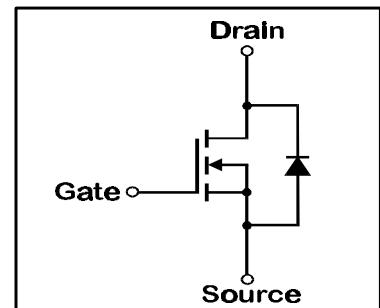
**> Applications**

- Switching Regulators
- UPS
- DC-DC converters
- General Purpose Power Amplifier

**> Outline Drawing**

**> Maximum Ratings and Characteristics**

- Absolute Maximum Ratings ( $T_C=25^\circ C$ ), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	$V_{DS}$	600	V
Continous Drain Current	$I_D$	2	A
Pulsed Drain Current	$I_{D(puls)}$	6	A
Continous Reverse Drain Current	$I_{DR}$	2	A
Gate-Source-Voltage	$V_{GS}$	$\pm 25$	V
Max. Power Dissipation	$P_D$	30	W
Operating and Storage Temperature Range	$T_{ch}$	150	$^\circ C$
	$T_{stg}$	-55 ~ +150	$^\circ C$

**> Equivalent Circuit**


- Electrical Characteristics ( $T_C=25^\circ C$ ), unless otherwise specified

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	$V_{(BR)DSS}$	$I_D=1mA$ $V_{GS}=0V$	600			V
Gate Threshold Voltage	$V_{GS(th)}$	$I_D=10mA$ $V_{DS}=V_{GS}$	2,1	3,0	4,0	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=600V$ $T_{ch}=25^\circ C$ $V_{GS}=0V$ $T_{ch}=125^\circ C$		10	500	$\mu A$
Gate Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 30V$ $V_{DS}=0V$		10	100	nA
Drain Source On-State Resistance	$R_{DS(on)}$	$I_D=1A$ $V_{GS}=10V$		5,5	6,5	$\Omega$
Forward Transconductance	$g_{fs}$	$I_D=1A$ $V_{DS}=25V$	1	1,8		S
Input Capacitance	$C_{iss}$	$V_{DS}=25V$		270	400	pF
Output Capacitance	$C_{oss}$	$V_{GS}=0V$		32	48	pF
Reverse Transfer Capacitance	$C_{rss}$	$f=1MHz$		15	23	pF
Turn-On-Time $t_{on}$ ( $t_{on}=t_{d(on)}+t_r$ )	$t_{d(on)}$	$V_{CC}=300V$		4	6	ns
	$t_r$	$I_D=2A$		12	18	ns
Turn-Off-Time $t_{off}$ ( $t_{off}=t_{d(off)}+t_f$ )	$t_{d(off)}$	$V_{GS}=10V$		25	40	ns
	$t_f$	$R_{GS}=25\Omega$		20	30	ns
Diode Forward On-Voltage	$V_{SD}$	$I_F=2xI_{DR}$ $V_{GS}=0V$ $T_{ch}=25^\circ C$		0,92	1,41	V
Reverse Recovery Time	$t_{rr}$	$I_F=I_{DR}$ $V_{GS}=0V$ $-dI_F/dt=100A/\mu s$ $T_{ch}=25^\circ C$		500		ns

**- Thermal Characteristics**

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance	$R_{th(ch-a)}$	channel to air			62,5	$^\circ C/W$
	$R_{th(ch-c)}$	channel to case			4,167	$^\circ C/W$

N-channel MOS-FET

600V 6,5Ω 2A 30W

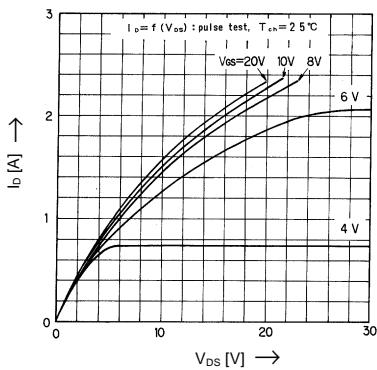
# 2SK1821-01MR

## FAP-IIA Series

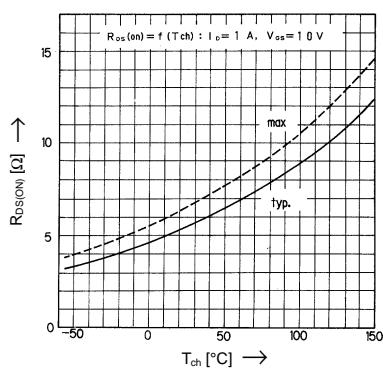
**FUJI**  
**ELECTRIC**

### > Characteristics

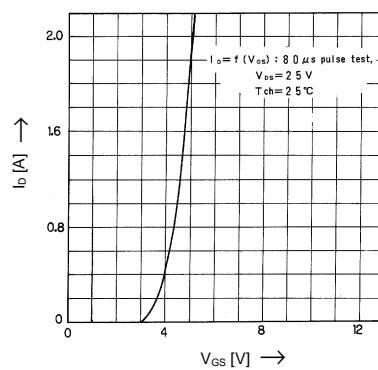
Typical Output Characteristics



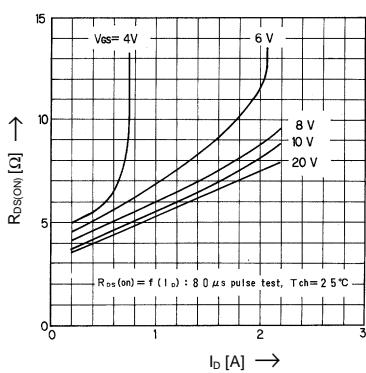
Drain-Source-On-State Resistance vs. Tch



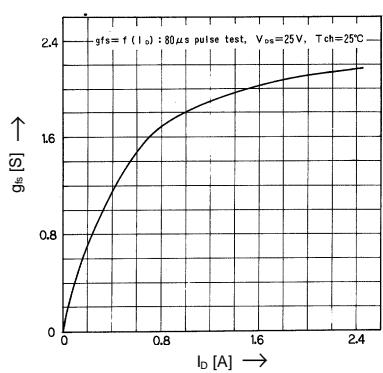
Typical Transfer Characteristics



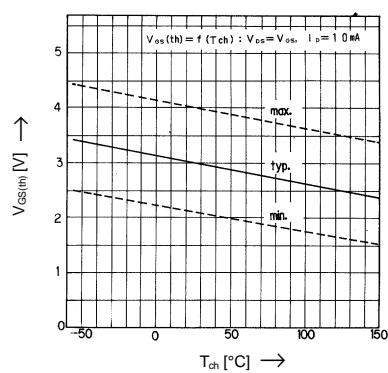
Typical Drain-Source-On-State-Resistance vs. ID



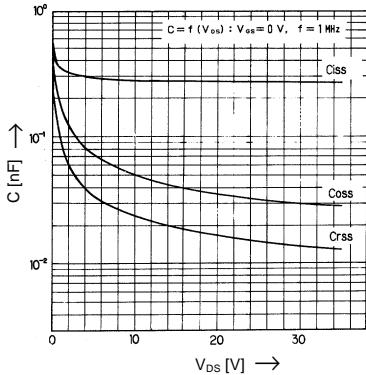
Typical Forward Transconductance vs. ID



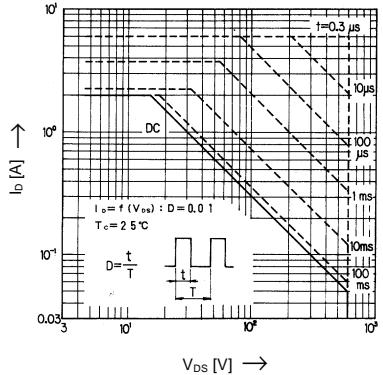
Gate Threshold Voltage vs. Tch



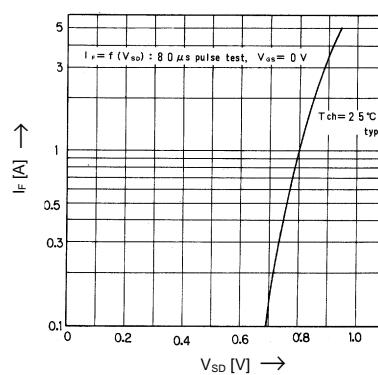
Typical Capacitance vs. VDS



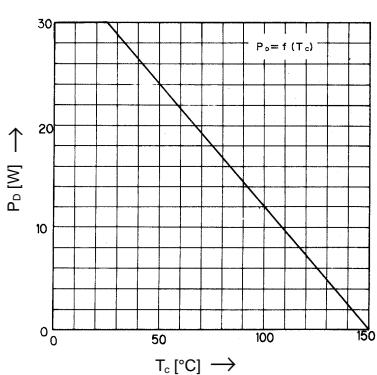
Safe operation area



Forward Characteristics of Reverse Diode



Allowable Power Dissipation vs. Tc



↑

Z<sub>th(dhc)</sub> [K/W]

Transient Thermal impedance

